



2 Drawing for packing (No scale)

5 Recommended land pattern dimension of PCB

Drawing for mating (No scale)

- 1 Lead CO-Planarity is 0.1mm MAX.
- 2 This is packaged in tray. (60pcs/tray)
- 3 Blemish and hit mark can be occurred through out the manufacturing process which dosen't affect quality level.
- 4 Please note that excessive wrenching force could damage this connector. Please refer to the guideline for detailed regulations of the mating method.
- 5 No prohibited area for printing pattern or via hole. PCB resist can be printed optionally.
- 6 The dimensions in parentheses are for references.

1	LCP	BLACK UL94V-0	4	BRASS	TIN-PLATING 1 μm
			2.3	PHOSPHOR BRONZE	CONTACT AREA:GOLD 0.1 μm
					LEAD AREA:GOLD 0.03 μm
					UNDER PLATING:NICKEL 1 μm
NO.	MATERIAL	FINISH . REMARKS	NO.	MATERIAL	FINISH . REMARKS
UNITS	mm	SCALE 2 : 1	COUNT	DESCRIPTION OF REVISIONS	DESIGNED
					CHECKED
					DATE
APPROVED : HS. OKAWA 13.09.25			DRAWING NO. EDC3-348428-00		
CHECKED : KI. HIROKAWA 13.09.25			PART NO. FX20-80S-0.5SH		
DESIGNED : TS. OONO 13.09.25			CODE NO. CL570-1603-3-00		
DRAWN : TS. OONO 13.09.25					